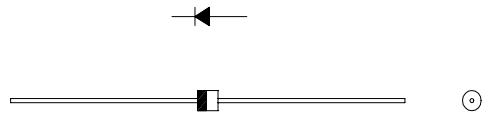


FRD Type : 11EFS2

OUTLINE DRAWING

FEATURES

- * Miniature Size
- * Ultra-Fast Recovery
- * Low Forward Voltage Drop
- * Low Power Loss, High Efficiency
- * High Surge Capability
- * 200 Volts through 400 Volts Types Available
- * 26mm and 52mm Inside Tape Spacing



Maximum Ratings

Approx Net Weight: 0.17g

Rating	Symbol	11EFS2			Unit
Repetitive Peak Reverse Voltage	V _{RRM}	200			V
Non-repetitive Peak Reverse Voltage	V _{RSM}	220			V
Average Rectified Output Current	I _O	0.8	T _a =40°C Without Fin *1	50Hz Half Sine Wave Resistive Load	A
		1	T _a =32°C P.C.B.Mounted*2		
RMS Forward Current	I _{F(RMS)}	1.57			A
Surge Forward Current	I _{FSM}	30	50Hz Half Sine Wave, 1cycle, Non-repetitive		A
Operating Junction Temperature Range	T _{jw}	- 40 to + 150			°C
Storage Temperature Range	T _{stg}	- 40 to + 150			°C

Electrical • Thermal Characteristics

Characteristics	Symbol	Conditions		Min	Typ	Max	Unit
Peak Reverse Current	I _{RM}	T _j = 25°C, V _{RM} = V _{RRM}		-	-	10	μA
Peak Forward Voltage	V _{FM}	T _j = 25°C, I _{FM} = 1 A		-	-	0.98	V
Reverse Recovery Time	trr	I _{FM} = 1 A, -di/dt= 50 A/μs, T _a = 25°C		-	-	30	ns
Thermal Resistance	R _{th(j-a)}	Junction to Ambient		Without Fin, PCB *1		140	°C/W
				P.C. Board Mounted *2			

*1 Without Fin or P.C.Board

*2 P.C. Board Mounted(L=3mm, Print Lands = 5x5 mm, Both Sides)

11EFS2 OUTLINE DRAWING (Dimensions in mm)

